

SMT970-29

Lead (Pb) Free Product RoHS Compliant

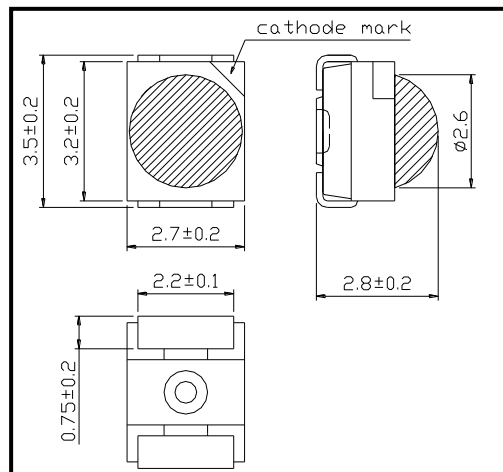
High Performance Infrared TOP IR LED

SMT970-29 consists of a GaAs LED mounted on the lead frame as TOP LED package and is 12mW typical of output power.
It emits a spectral band of radiation at 970nm.

◆Specifications

1) Product Name	TOP IR LED
2) Type No.	SMT970-29
3) Chip	
(1) Chip Material	GaAs
(2) Chip Dimension	0.4mm*0.4mm
(3) Peak Wavelength	970nm typ.
4) Package	
(1) Lead Frame Die	Silver Plated
(2) Package Resin	PPA Resin
(3) Lens	Epoxy Resin

◆Outer dimension (Unit: mm)



◆Electro-Optical Characteristics [Ta=25°C]

Item	Symbol	Maximum Rated Value	Unit	Ambient Temperature
Power Dissipation	P _D	150	mW	Ta=25°C
Forward Current	I _F	100	mA	Ta=25°C
Pulse Forward Current	I _{FP}	500	mA	Ta=25°C
Reverse Voltage	V _R	5	V	Ta=25°C
Junction Temperature	T _J	100	°C	
Thermal Resistance	R _{thja}	190	K/W	
Operating Temperature	T _{OPR}	-30 ~ +80	°C	
Storage Temperature	T _{STG}	-40 ~ +80	°C	
Soldering Temperature	T _{SOL}	255	°C	

‡Pulse Forward Current condition: Duty=1% and Pulse Width=10us.

‡Soldering condition: Soldering condition must be completed within 10 seconds at 255°C

◆Electro-Optical Characteristics [Ta=25°C]

Item	Symbol	Condition	Minimum	Typical	Maximum	Unit
Forward Voltage	V _F	I _F =50mA DC		1.30	1.45	V
		I _F =100mA, tp=20ms		1.42	1.57	
Reverse Current	I _R	V _R =5V			10	uA
Total Radiated Power	P _O	I _F =50mA DC	3.0	6.0		mW
		I _F =100mA, tp=20ms		12.0		
Radiant Intensity	I _E	I _F =50mA DC		2.3		mW/sr
		I _F =100mA, tp=20ms		4.6		
Peak Wavelength	λ _P	I _F =50mA DC	960	970	980	nm
Half Width	Δλ	I _F =50mA DC		50		nm
Viewing Half Angle	θ1/2	I _F =50mA DC		±49		deg.
Rise Time	t _r	I _F =50mA DC		1000		ns
Fall Time	t _f	I _F =50mA DC		500		ns

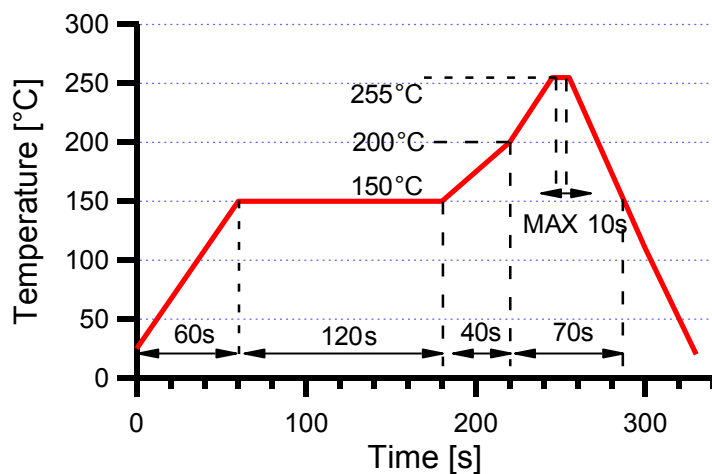
‡Total Radiated Power is measured by S3584-08

‡Radiant Intensity is measured by Tektronix J-6512.

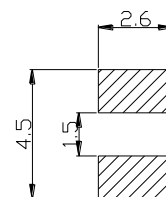
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- ◆ SMD Application
IR-Reflow Soldering Profile for lead free soldering

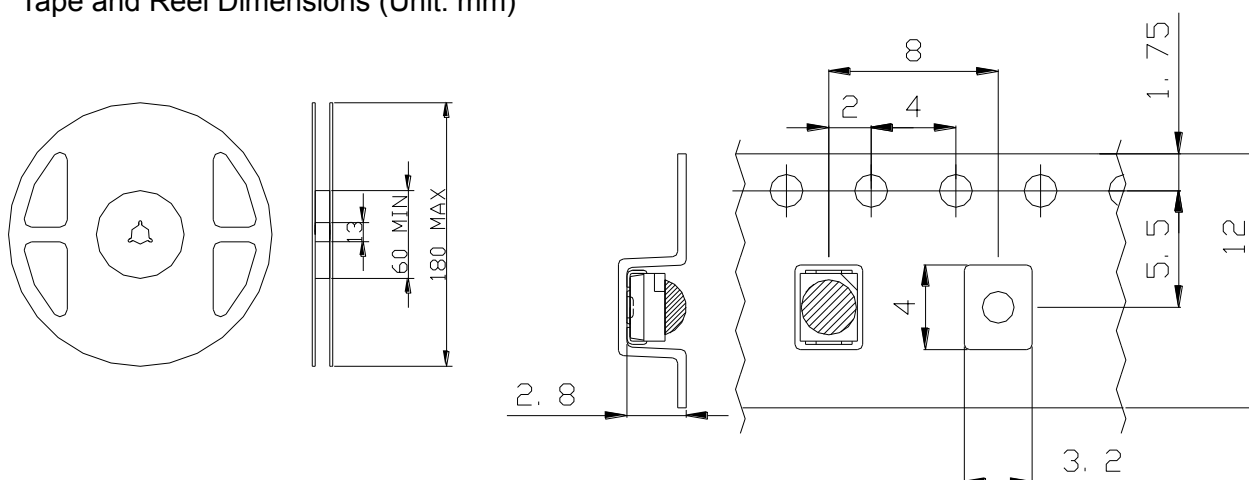


Recommended Land Layout (Unit: mm)



Don't put stress on SMD and a circuit board after soldering.

- ◆ SMD Packing
Tape and Reel Dimensions (Unit: mm)



- ◆ Wrapping
Moisture barrier bag aluminum laminated film with a desiccant to keep out the moisture absorption during the transportation and storage.

SMD LED STORAGE AND HANDLING PRECAUTIONS

<Storage Conditions before Opening a Moisture-Barrier Aluminum Bag>

- Before opening a moisture-barrier aluminum bag, please store it at <30°C, <60%RH. Please note that the maximum shelf life is 12 months under these conditions.

<Storage Conditions after Opening a Moisture-Barrier Aluminum Bag>

- After opening a moisture-barrier aluminum bag, store the aluminum bag and silica gel in a desiccator.
- After opening the bag, please solder the LEDs within 72 hours in a room with 5 - 30°C, <50%RH.
- Please put any unused, remaining LEDs and silica gel back in the same aluminum bag and then vacuum-seal the bag.
- It is recommended to keep the re-sealed bag in a desiccator at <30%RH.

<Notes about Re-sealing a Moisture-Barrier Aluminum Bag>

- When vacuum-sealing an opened aluminum bag, if you find the moisture-indicator of the silica gel has changed to pink from blue (indicating a relative humidity of 30 % or more), please do not use the unused LEDs, the aluminum bag, or the silica gel.

<Notes about Opening a Re-sealed Moisture-Barrier Aluminum Bag>

- When opening a vacuumed and re-sealed aluminum bag in order to use the remaining LEDs stored in the bag, if you find that the moisture-indicator of the silica has changed to pink, please do not use the LEDs.

※The 72-hour- long floor life does not include the time while LEDs are stored in the moisture-barrier aluminum bag.
However, we strongly recommend to solder the LEDs as soon as possible after opening the aluminum bag.